# Adding New Assembly Site Location for Spartan 6, Artix 7, Kintex 7, Zynq 7000, Spartan 7, Kintex UltraScale, Zynq UltraScale+ and Spartan UltraScale+ Families

XCN26005 (v1.1) September 21, 2026 Product Change Notice

## Overview

The purpose of this notification is to announce that Advanced Micro Devices, Inc. is qualifying an additional assembly site location operated by our approved assembly partner, Siliconware Precision Industries Co., Ltd (SPIL). This qualification applies to specific devices within the Spartan™ 6, Artix™ 7, Kintex™ 7, Zynq™ 7000, Spartan 7, Kintex UltraScale™, Zynq UltraScale+™ and Spartan UltraScale+™ families.

## Description

AMD is qualifying an additional SPIL assembly site location to ensure supplier continuity and meet customers' increasing volume requirements worldwide. The new site is an established high-volume manufacturing facility that employs the same qualified processes, equipment, packaging materials, and supplier base as the existing assembly location.

This expansion increases manufacturing capacity while preserving complete product consistency. There are no changes to package reliability, form, fit, function, external dimensions, or package outline drawings, ensuring a seamless experience for customers with no impact to product performance or quality.

## Products Affected

This change affects all speed, grade, package, and temperature variations of "XC" commercial device-package combinations listed in the tables below. Any associated Specification Control Documents (SCDs) listed in the tables below are also affected.

*Table 1:* **Spartan 6 FPGA Affected Products**

| Device | Package |
|---|---|
| XC6SLX16 | FTG256 |
| XC6SLX25 | FTG256 |
| XC6SLX9 | FTG256 |

*Table 2:* **Artix 7 FPGA Affected Products**

| Device | Package |
|---|---|
| XC7A200T | FFG1156 |
| XC7A200T | FBG676 |
| XC7A200T | FB676 |
| XC7A200T | FBG484 |
| XC7A200T | FB484 |

*Table 2:* **Artix 7 FPGA Affected Products (cont.)**

| Device | Package |
|---|---|
| XC7A100T | FTG256 |
| XC7A15T | FTG256 |
| XC7A25T | CSG325 |
| XC7A35T | CSG324 |
| XC7A35T | CSG325 |
| XC7A50T | CSG324 |
| XC7A50T | CSG325 |

*Table 3:* **Kintex 7 FPGA Affected Products**

| Device | Package |
|---|---|
| XC7K160T | FFG676 |
| XC7K160T | FF676 |
| XC7K325T | FFG900 |
| XC7K70T | FBG484 |
| XC7K70T | FB484 |

*Table 4:* **Zynq 7000 SoC Affected Products**

| Device | Package |
|---|---|
| XC7Z030 | FBG484 |
| XC7Z030 | FB484 |
| XC7Z007S | CLG225 |
| XC7Z007S | CLG400 |
| XC7Z010 | CLG400 |
| XC7Z015 | CLG485 |
| XC7Z020 | CLG400 |
| XC7Z020 | CLG484 |

*Table 5:* **Spartan 7 FPGA Affected Products**

| Device | Package |
|---|---|
| XC7S15 | CPGA196 |
| XC7S25 | CSGA225 |
| XC7S25 | CSGA324 |
| XC7S50 | CSGA324 |
| XC7S6 | CPGA196 |

*Table 6:* **Kintex UltraScale FPGA Affected Products**

| Device | Package |
|---|---|
| XCKU035 | SFVA784 |
| XCKU035 | FFVA1156 |
| XCKU040 | FFVA1156 |

*Table 7:* **Spartan UltraScale+ FPGA Affected Product**

| Device | Package |
|---|---|
| XCSU35P | SBVB625 |

*Table 8:* **Zynq UltraScale+ SoC Affected Products**

| Device | Package |
|---|---|
| XCZU2CG | SFVC784 |
| XCZU2EG | SFVC784 |
| XCZU3EG | SFVC784 |

## Key Dates and Ordering Information

AMD will begin cross shipping the devices from the new assembly site location starting January 2027.

## Qualification Data

Qualification data will be available upon request.

## Response

Acknowledgement is required within 30 days of receipt of this notice. No feedback or response of the PCN within 30 days constitutes acceptance of the change. For additional information or questions, please contact your AMD sales representative.

**Important Notice:** AMD Customer Notifications (XCNs, XDNs, and Quality Alerts) can be delivered via e-mail alerts sent by the Support website (https://docs.xilinx.com/home). Register today and personalize your “Documentation and Design Advisory Alerts” area to include Customer Notifications. AMD Support provides many benefits, including the ability to receive alerts for new and updated information about specific products, as well as alerts for other publications such as data sheets, errata, application notes, etc. For information on how to sign up, refer to Answer Record 18683.

## Revision History

The following table shows the revision history for this document.

| Date | Version | Revision |
|---|---|---|
| 09/14/2026 | 1.0 | Initial Release |
| 09/21/2026 | 1.1 | Updated Table 4 |

# Please Read: Important Legal Notices

The information presented in this document is for informational purposes only and may contain technical inaccuracies, omissions, and typographical errors. The information contained herein is subject to change and may be rendered inaccurate for many reasons, including but not limited to product and roadmap changes, component and motherboard version changes, new model and/or product releases, product differences between differing manufacturers, software changes, BIOS flashes, firmware upgrades, or the like. Any computer system has risks of security vulnerabilities that cannot be completely prevented or mitigated. AMD assumes no obligation to update or otherwise correct or revise this information. However, AMD reserves the right to revise this information and to make changes from time to time to the content hereof without obligation of AMD to notify any person of such revisions or changes. THIS INFORMATION IS PROVIDED “AS IS.” AMD MAKES NO REPRESENTATIONS OR WARRANTIES WITH RESPECT TO THE CONTENTS HEREOF AND ASSUMES NO RESPONSIBILITY FOR ANY INACCURACIES, ERRORS, OR OMISSIONS THAT MAY APPEAR IN THIS INFORMATION. AMD SPECIFICALLY DISCLAIMS ANY IMPLIED WARRANTIES OF NON-INFRINGEMENT, MERCHANTABILITY, OR FITNESS FOR ANY PARTICULAR PURPOSE. IN NO EVENT WILL AMD BE LIABLE TO ANY PERSON FOR ANY RELIANCE, DIRECT, INDIRECT, SPECIAL, OR OTHER CONSEQUENTIAL DAMAGES ARISING FROM THE USE OF ANY INFORMATION CONTAINED HEREIN, EVEN IF AMD IS EXPRESSLY ADVISED OF THE POSSIBILITY OF SUCH DAMAGES.

**AUTOMOTIVE APPLICATIONS DISCLAIMER**

AUTOMOTIVE PRODUCTS (IDENTIFIED AS "XA" IN THE PART NUMBER) ARE NOT WARRANTED FOR USE IN THE DEPLOYMENT OF AIRBAGS OR FOR USE IN APPLICATIONS THAT AFFECT CONTROL OF A VEHICLE ("SAFETY APPLICATION") UNLESS THERE IS A SAFETY CONCEPT OR REDUNDANCY FEATURE CONSISTENT WITH THE ISO 26262 AUTOMOTIVE SAFETY STANDARD ("SAFETY DESIGN"). CUSTOMER SHALL, PRIOR TO USING OR DISTRIBUTING ANY SYSTEMS THAT INCORPORATE PRODUCTS, THOROUGHLY TEST SUCH SYSTEMS FOR SAFETY PURPOSES. USE OF PRODUCTS IN A SAFETY APPLICATION WITHOUT A SAFETY DESIGN IS FULLY AT THE RISK OF CUSTOMER, SUBJECT ONLY TO APPLICABLE LAWS AND REGULATIONS GOVERNING LIMITATIONS ON PRODUCT LIABILITY.

© Copyright 2026 Advanced Micro Devices, Inc. AMD, the AMD Arrow logo, Artix, Kintex, Spartan, Zynq, UltraScale, UltraScale+, and combinations thereof are trademarks of Advanced Micro Devices, Inc. Other product names used in this publication are for identification purposes only and may be trademarks of their respective companies.